

# MA6Z121 (MA6S121)

Silicon epitaxial planar type

For switching circuit

## ■ Features

- Small S-mini type 6-pin package
- Three isolated elements contained in one package, allowing high-density mounting
- Flat lead type, resulting in improved mounting efficiency and solderability with the high-speed mounting machine
- Short reverse recovery time  $t_{rr}$
- Small terminal capacitance,  $C_t$

## ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	$V_R$	80	V
Peak reverse voltage	$V_{RM}$	80	V
Average forward current* <sup>1</sup>	$I_{F(AV)}$	100	mA
Peak forward current* <sup>1</sup>	$I_{FM}$	225	mA
Non-repetitive peak forward surge current* <sup>1,2</sup>	$I_{FSM}$	500	mA
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

Note) \*1 : Value for single diode

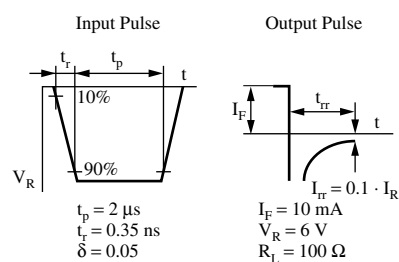
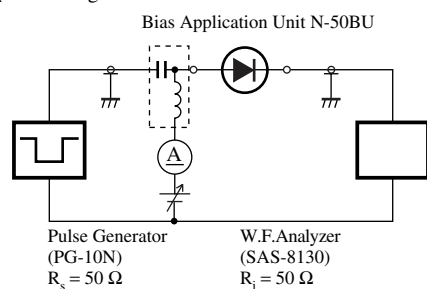
\*2 :  $t = 1 \text{ s}$

## ■ Electrical Characteristics $T_a = 25^\circ\text{C}$

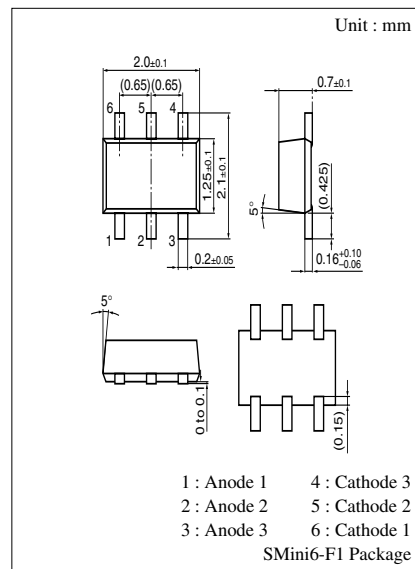
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse current (DC)	$I_R$	$V_R = 75 \text{ V}$			0.1	$\mu\text{A}$
Forward voltage (DC)	$V_F$	$I_F = 100 \text{ mA}$			1.2	V
Reverse voltage (DC)	$V_R$	$I_R = 100 \mu\text{A}$	80			V
Terminal capacitance	$C_t$	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$			2	pF
Reverse recovery time*	$t_{rr}$	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$ $I_{rr} = 0.1 \cdot I_R, R_L = 100 \Omega$			3	ns

Note) 1. Rated input/output frequency: 100 MHz

2. \* :  $t_{rr}$  measuring circuit

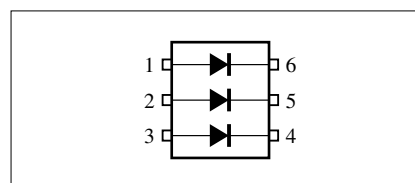


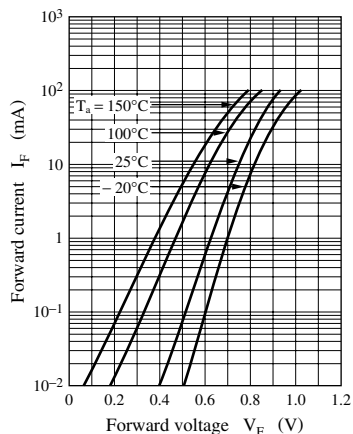
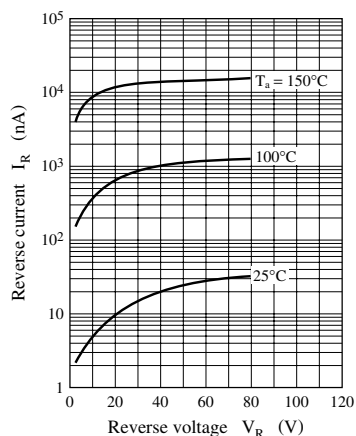
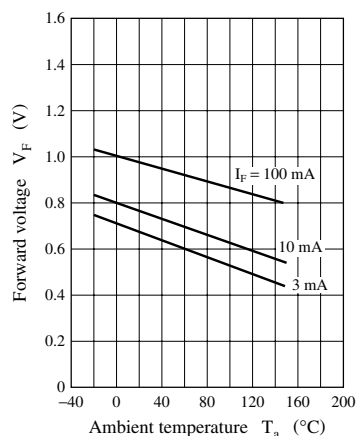
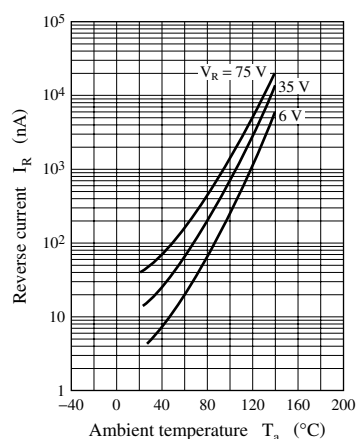
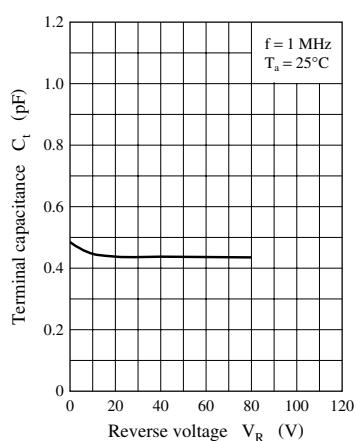
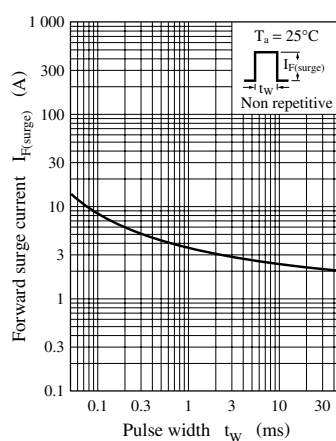
Note) The part number in the parenthesis shows conventional part number.



Marking Symbol: M2D

Internal Connection



$I_F - V_F$  $I_R - V_R$  $V_F - T_a$  $I_R - T_a$  $C_t - V_R$  $I_{F(\text{surge})} - t_w$ 

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